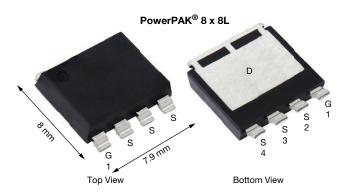
SQJQ186E

www.vishay.com

Vishay Siliconix

Automotive N-Channel 80 V (D-S) 175 °C MOSFET

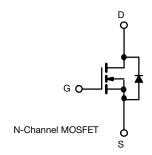


PRODUCT SUMMARY				
V _{DS} (V)	80			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0023			
I _D (A)	245			
Configuration	Single			
Package	PowerPAK 8 x 8L			

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % Rg and UIS tested
- Thin 1.9 mm height
- Material categorization for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	80	V	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current	T _C = 25 °C	1	245		
	T _C = 125 °C	- I _D	141		
Continuous source current (diode conduction)		۱ _S	245	А	
Pulsed drain current ^a		I _{DM}	770		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	58		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	168	mJ	
Maximum power dissipation	T _C = 25 °C	Р	357	W	
	T _C = 125 °C	P _D	119	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260	U	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	40	°C/W	
Junction-to-case (drain)		R _{thJC}	0.42	C/ W	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty}~\text{cycle} \leq 2~\%$

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>)

Vishay Siliconix

SQJQ186E

VICLIAY	
VISHAY	www.visha

	-1 - I		
www.v	/ 9	nav	com
		i i Cu y	.00111

PARAMETER	SYMBOL	L TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		80	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.5	3	3.5	v	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = 80 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 175 °C	-	-	500		
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	50	-	-	А	
		$V_{GS} = 10 V$	I _D = 20 A	-	0.0019	0.0023		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}$	$I_D = 20 \text{ A}, \text{T}_\text{J} = 125 \ ^\circ\text{C}$	-	-	0.0047	Ω	
		$V_{GS} = 10 V$	I _D = 20 A, T _J = 175 °C	-	-	0.0060		
Forward transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		-	90	-	S	
Dynamic ^b								
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	7537	10 552	pF	
Output capacitance	Coss	$V_{GS} = 0 V$		-	1182	1655		
Reverse transfer capacitance	C _{rss}			-	55	77		
Total gate charge ^c	Qg			-	123	185	nC	
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 \text{ V}$	= 10 V V _{DS} = 40 V, I _D = 50 A	-	36	-		
Gate-drain charge ^c	Q _{gd}			-	26	-		
Gate resistance	Rg	f = 1 MHz		0.6	1.3	2	Ω	
Turn-on delay time ^c	t _{d(on)}	$\label{eq:VDD} \begin{array}{l} V_{DD} = 40 \text{ V}, \ R_L = 4 \ \Omega, \\ I_D \cong 10 \text{ A}, \ V_{GEN} = 10 \text{ V}, \ R_g = 1 \ \Omega \end{array}$		-	22	33		
Rise time ^c	t _r			-	21	32	- ns	
Turn-off delay time ^c	t _{d(off)}			-	53	80		
Fall time ^c	t _f			-	16	24		
Source-Drain Diode Ratings and Charac	teristics ^b							
Pulsed current ^a	I _{SM}			-	-	770	Α	
Forward voltage	V _{SD}	I _F = 40 A, V _{GS} = 0 V		-	0.7	1.2	V	
Body diode reverse recovery time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs		-	63	126	ns	
Body diode reverse recovery charge	Q _{rr}			-	105	210	nC	
Reverse recovery fall time	t _a			-	32	-		
Reverse recovery rise time	t _b			-	31	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-3.0	-	А	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},~\text{duty}~\text{cycle} \leq 2~\%$

b. Guaranteed by design, not subject to production testing

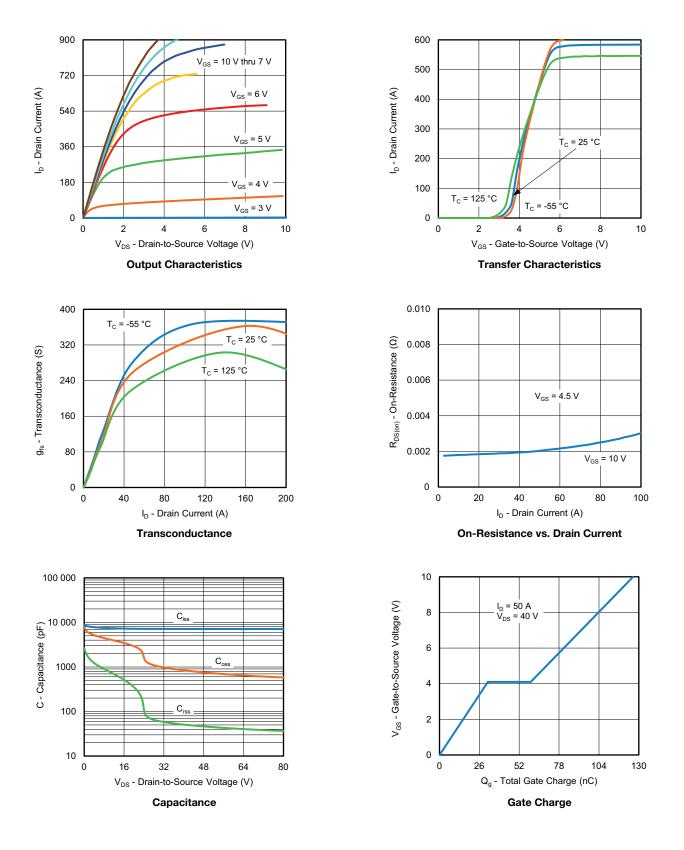
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Vishay Siliconix

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



S22-0351-Rev. A, 25-Apr-2022

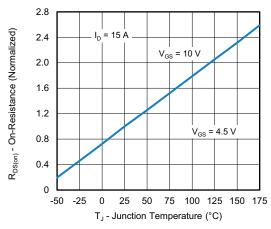
3

For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

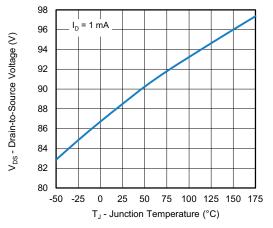


Vishay Siliconix

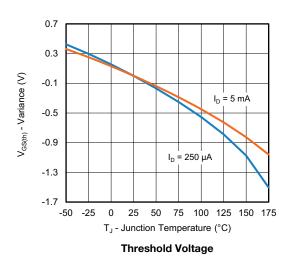
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

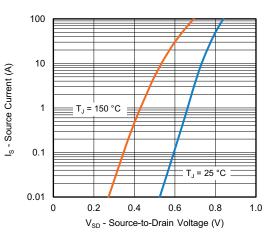


On-Resistance vs. Junction Temperature

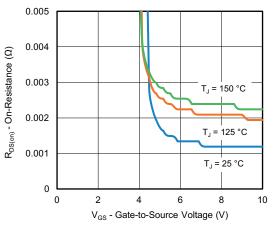


Drain Source Breakdown vs. Junction Temperature

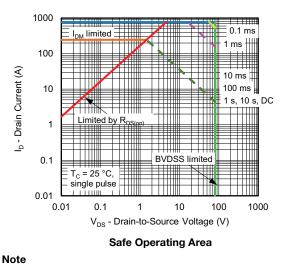




Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Note a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

S22-0351-Rev. A, 25-Apr-2022

4

Document Number: 62006

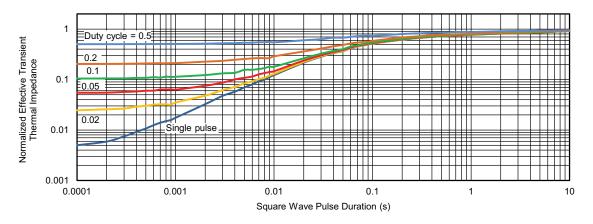
For technical questions, contact: <u>automostechsupport@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



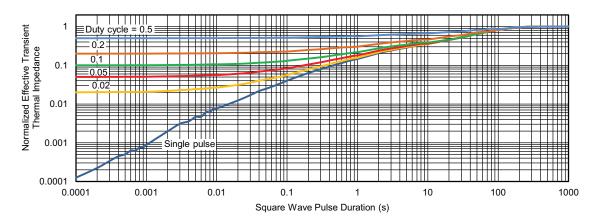
SQJQ186E

Vishay Siliconix

THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?62006</u>.

S22-0351-Rev. A, 25-Apr-2022	5	Document Number: 62006		
For technical questions, contact: <u>automostechsupport@vishay.com</u>				
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT				
ARE SUB.	JECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishav.co</u>	<u>m/doc?91000</u>		



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.